

PRODUCT/PROCESS CHANGE NOTICE (PCN)						
PCN #:	G-0206-09	DATE: 6/17/2002	MEANS OF DIST	TINGUISHING CHAN	GED DEVICES:	
Product Affected: MQFP, PQFP and TQFP packages in			☐ Product Mark	☐ Product Mark		
Tape and Reel			☐ Back Mark			
T. T. T. C.			☐ Date Code	7		
Date Effective: 9/30/2002			■ Other	Starting ww40		
Contact: Geoffrey Cortes						
• •		te Quality & Reliability	Attachment::	☐ Yes	No	
Phone #: (408) 492-8321						
Fax #: (408) 727-2328			Samples: N/A			
E-mail:	nail: <u>Geoffrey.Cortes@idt.com</u>					
DESCRIPTION AND PURPOSE OF CHANGE: Die Technology Wafer Fabrication Process Assembly Process Equipment Material Testing Manufacturing Site Data Sheet Other This PCN effects product shipped in Tape and Reel only. RELIABILITY/QUALIFICATION SUMMARY: Not applicable. Shipping material change only. CUSTOMER ACKNOWLEDGMENT OF RECEIPT: IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.						
Customer:			☐ Approval for s	shipments prior to	effective date.	
Name/Date:		E-Mail Address:				
Title:		Phone# /Fax#:				
CUSTOMER COMMENTS:						
IDT ACKNOWLEDGMENT OF RECEIPT:						
RECD. BY:		DATE:		_		